

MOSFET MODULE

FCA50CC50

TOP



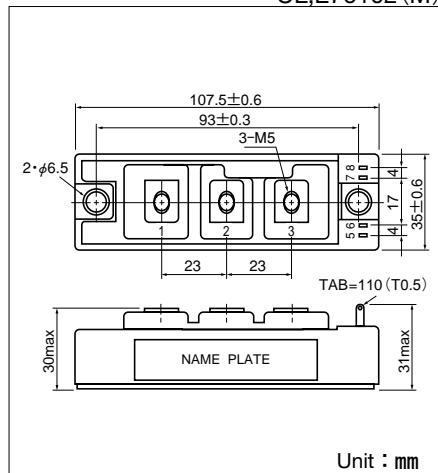
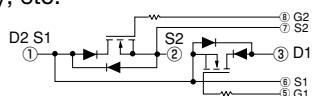
UL;E76102 (M)

FCA50CC50 is a dual power MOSFET module designed for fast switching applications of high voltage and current. (2 devices are serial connected with a fast recovery diode ($t_{rr} \leq 100\text{ns}$) reverse connected across each MOSFET.) The mounting base of the module is electrically isolated from semiconductor elements for simple heatsink construction.

- $I_D=50A$, $V_{DSS}=500V$
 - Suitable for high speed switching applications.
 - Low ON resistance.
 - Wide Safe Operating Areas.
 - $t_{rr} \leq 100ns$ fast recovery diode for free wheel.

(Applications)

UPS(CVCF), Motor Control, Switching Power Supply, etc.



Unit : mm

(T_j=25°C unless otherwise specified)

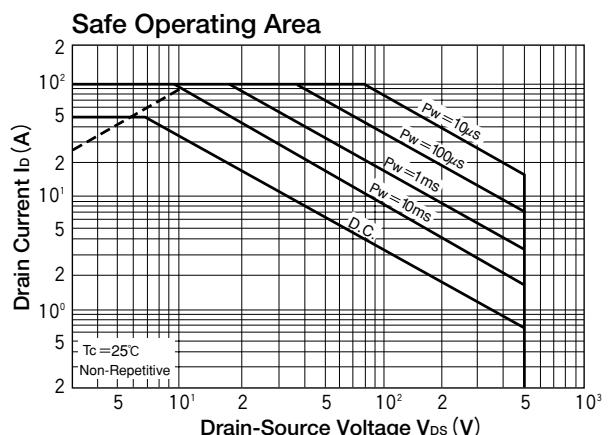
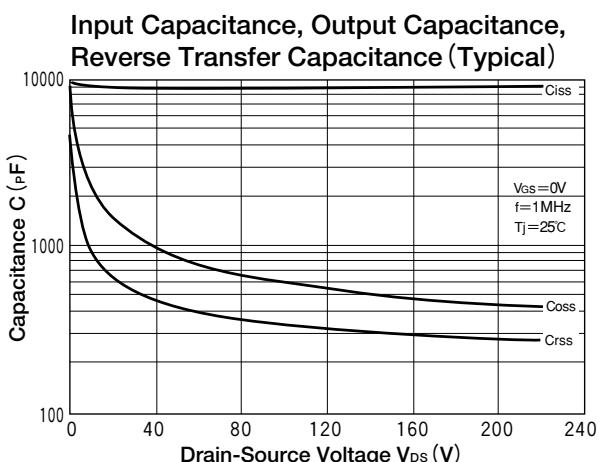
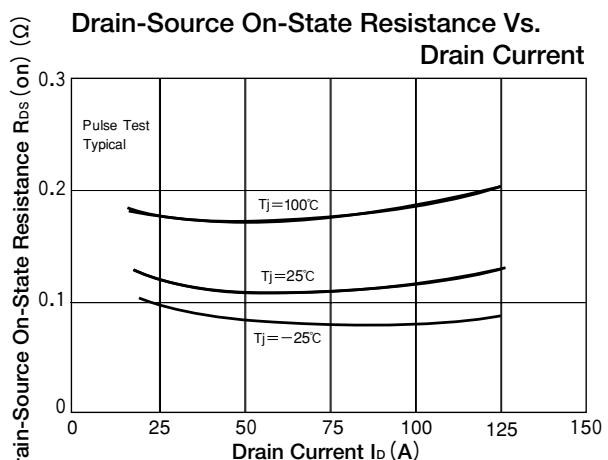
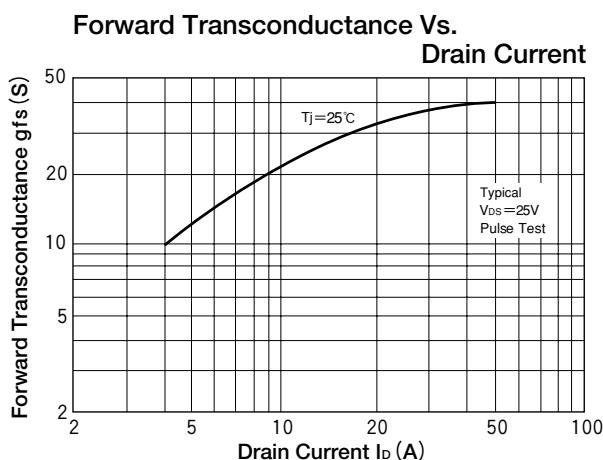
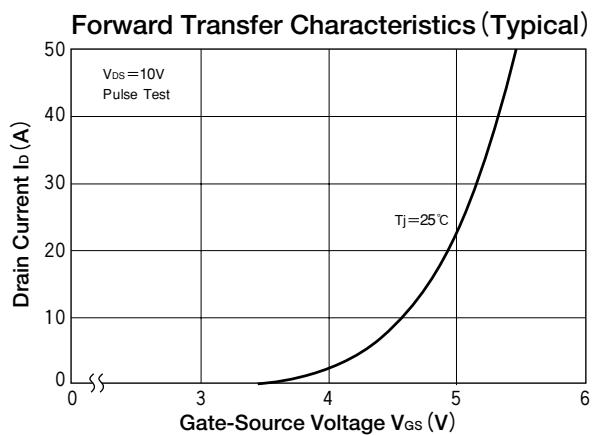
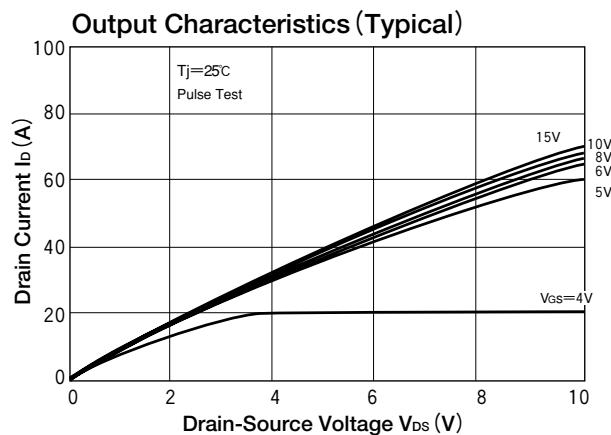
■ Maximum Ratings

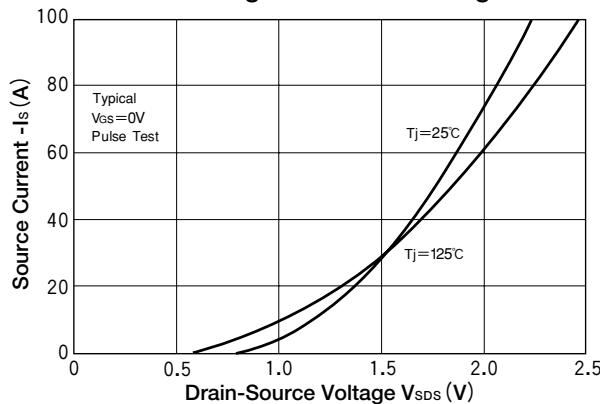
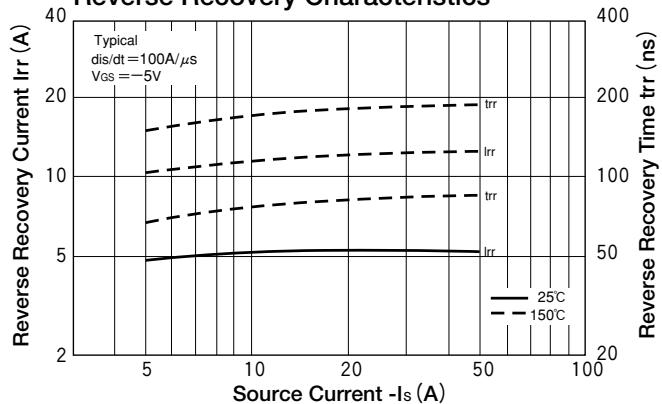
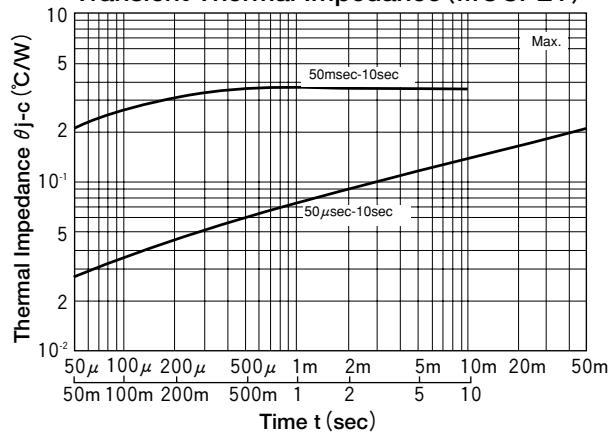
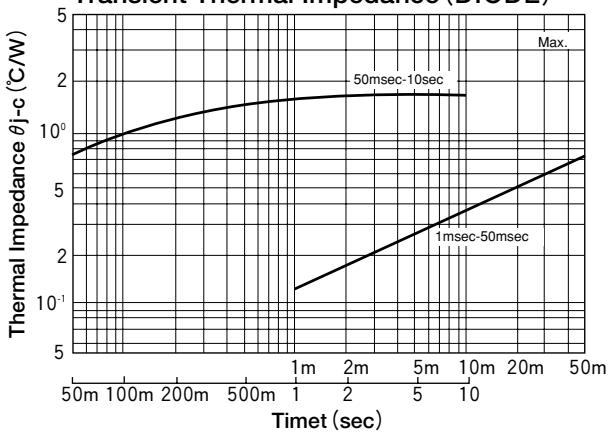
Symbol	Item		Conditions	Ratings	Unit
				FCA50CC50	
V _{DSS}	Drain-Source Voltage			500	V
V _{GSS}	Gate-Source Voltage			±20	V
I _D	Drain Current	DC	Duty 55%	50	A
I _{DP}		Pulse		100	
-I _D	Source Current			50	A
P _T	Total Power Dissipation		T _C =25°C	330	W
T _j	Channel Temperature			-40 to +150	°C
T _{STG}	Storage Temperature			-40 to +125	°C
V _{ISO}	Isolation Voltage (R.M.S.)		A.C. 1 minute	2500	V
	Mounting Torque	Mounting (M6)	Recommended Value 2.5-3.9 (25-40)	4.7 (48)	N·m (kgf·cm)
		Terminal (M5)	Recommended Value 1.5-2.5 (15-25)	2.7 (28)	
	Mass		Typical Value	240	g

■ Electrical Characteristics

($T_i=25^\circ\text{C}$ unless otherwise specified)

Symbol	Item	Conditions	Ratings			Unit
			Min.	Typ.	Max.	
I _{GS}	Gate Leakage Current	V _{GS} =±20V, V _{DS} =0V			±1.0	μA
I _{DSS}	Zero Gate Voltage Drain Current	V _{GS} =0V, V _{DS} =500V			1.0	mA
V _{(BR)DSS}	Darwin-Source Breakdown Voltage	V _{GS} =0V, I _D =1mA	500			V
V _{GS(th)}	Gate-Source Threshold Voltage	V _{DS} =V _{GS} , I _D =10mA	1.0		5.0	V
R _{DS(on)}	Drain-Source On-State Resistance	I _D =25A, V _{GS} =15V			140	mΩ
V _{DS(on)}	Drain-Source On-State Voltage	I _D =25A, V _{GS} =15V			3.5	V
g _{fs}	Forward Transconductance	V _{DS} =10V, I _D =25A		30		S
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =25V, f=1.0MHz			10000	pF
C _{oss}	Output Capacitance	V _{GS} =0V, V _{DS} =25V, f=1.0MHz			1900	pF
C _{rss}	Reverse Transfer Capacitance	V _{GS} =0V, V _{DS} =25V, f=1.0MHz			750	pF
t _{d(on)}	Switching Time	Turn-on Delay Time	V _{DD} =300V, V _{GS} =15V I _D =25A, R _G =5Ω	60		ns
t _r		Rise Time		100		
t _{d(off)}		Turn-off Delay Time		520		
t _f		Fall Time		140		
V _{sds}	Diode Forward Voltage	I _s =25A, V _{GS} =0V			2.0	V
t _{rr}	Reverse Recovery Time	I _s =25A, V _{GS} =-5V, di/dt=100A/μs		80	100	ns
R _{th(j-c)}	Thermal Resistance	MOSFET			0.38	°C/W
		Diode			1.67	



Forward Voltage of Free Wheeling Diode**Reverse Recovery Characteristics****Transient Thermal Impedance (MOSFET)****Transient Thermal Impedance (DIODE)**

MOSFET MODULE

FCA75CC50

TOP



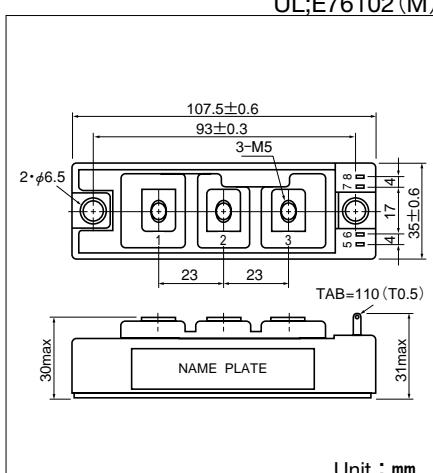
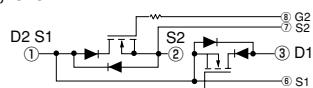
UL:E76102 (M)

FCA75CC50 is a dual power MOSFET module designed for fast switching applications of high voltage and current. (2 devices are serial connected with a fast recovery diode ($t_{rr} \leq 100\text{ns}$) reverse connected across each MOSFET.) The mounting base of the module is electrically isolated from semiconductor elements for simple heatsink construction.

- $I_D = 75\text{A}$, $V_{DSS} = 500\text{V}$
- Suitable for high speed switching applications.
- Low ON resistance.
- Wide Safe Operating Areas.
- $t_{rr} \leq 100\text{ns}$ fast recovery diode for free wheel.

(Applications)

UPS(CVCF), Motor Control, Switching Power Supply, etc.



($T_j = 25^\circ\text{C}$ unless otherwise specified)

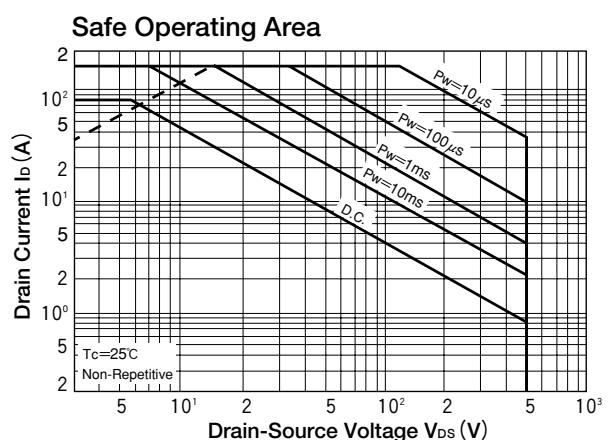
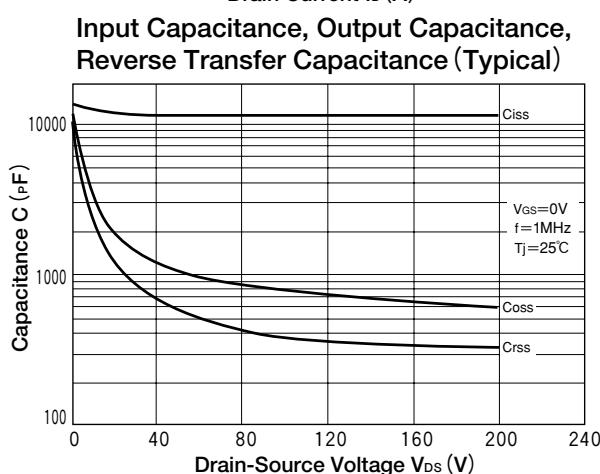
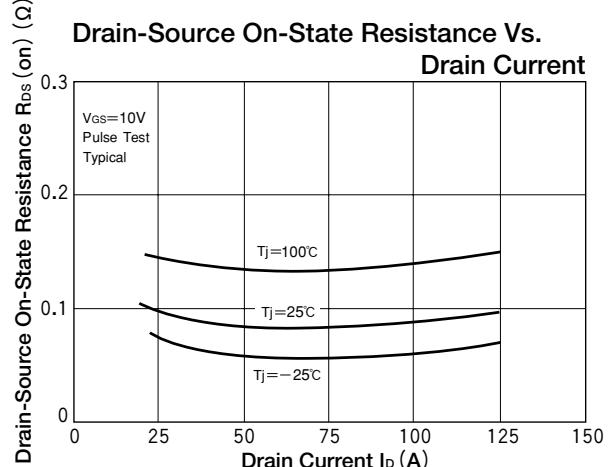
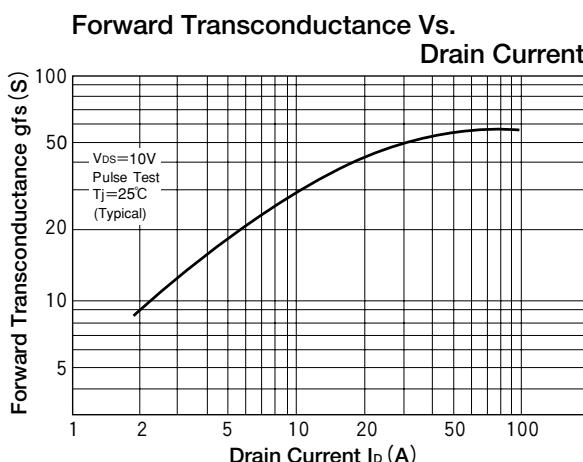
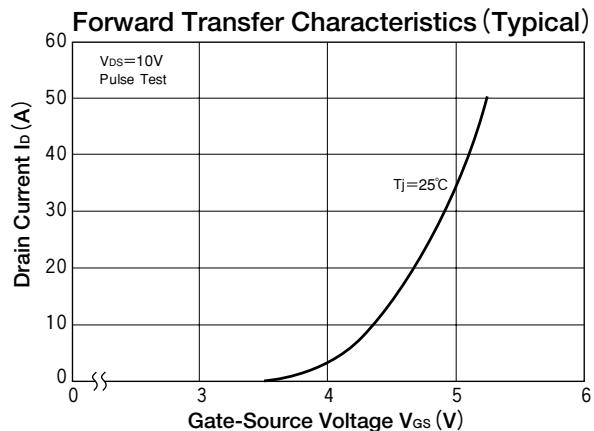
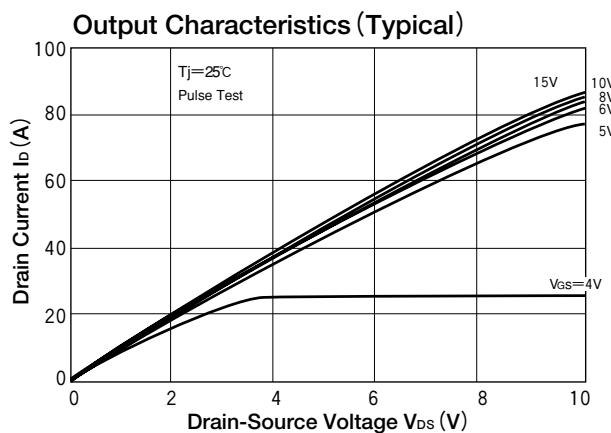
■ Maximum Ratings

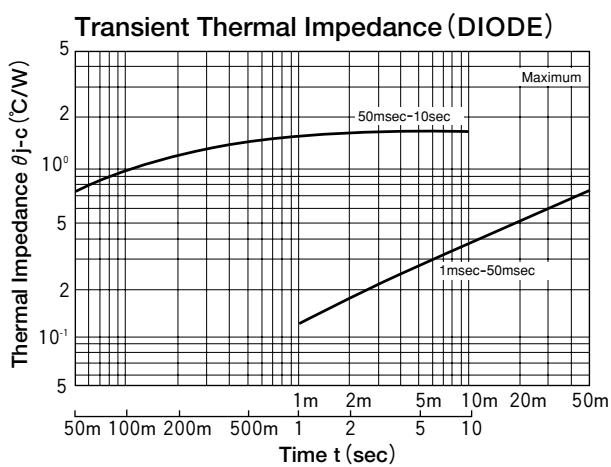
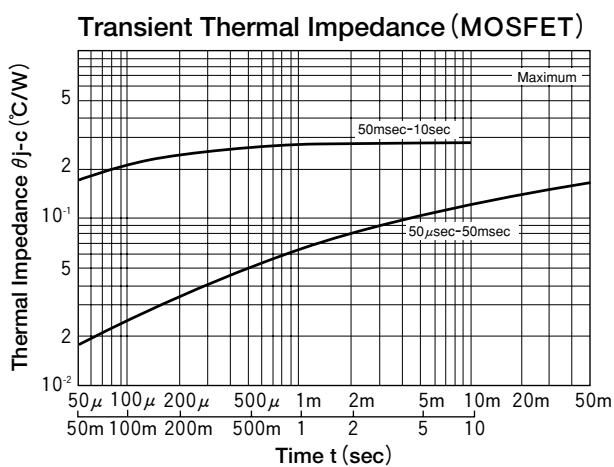
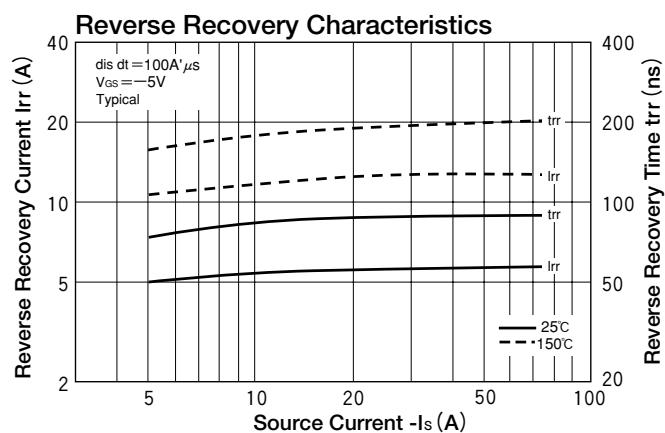
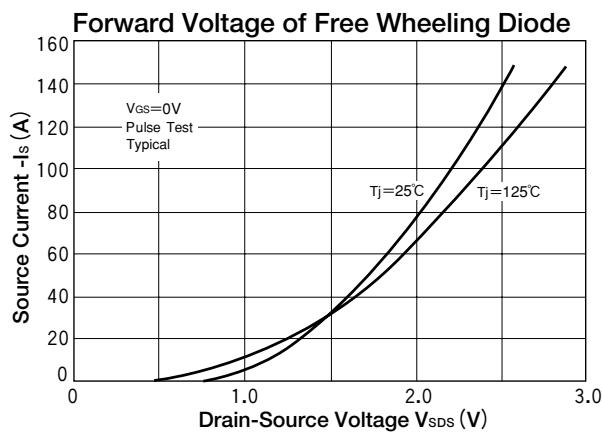
Symbol	Item	Conditions	Ratings	Unit
			FCA75CC50	
V_{DSS}	Drain-Source Voltage		500	V
V_{GSS}	Gate-Source Voltage		±20	V
I_D I_{DP}	Drain Current DC	Duty 35%	75	A
	Pulse		150	
$-I_D$	Source Current		75	A
P_T	Total Power Dissipation	$T_c = 25^\circ\text{C}$	430	W
T_j	Channel Temperature		-40 to +150	°C
T_{stg}	Storage Temperature		-40 to +125	°C
V_{iso}	Isolation Voltage (R.M.S.)	A.C. 1 minute	2500	V
Mounting Torque	Mounting (M6)	Recommended Value 2.5-3.9 (25-40)	4.7 (48)	N·m (kgf·cm)
	Terminal (M5)	Recommended Value 1.5-2.5 (15-25)	2.7 (28)	
Mass	Typical Value		240	g

■ Electrical Characteristics

($T_j = 25^\circ\text{C}$)

Symbol	Item	Conditions	Ratings			Unit
			Min.	Typ.	Max.	
I_{GS}	Gate Leakage Current	$V_{GS} = \pm 20\text{V}$, $V_{DS} = 0\text{V}$			±1.0	μA
I_{DS}	Zero Gate Voltage Drain Current	$V_{GS} = 0\text{V}$, $V_{DS} = 500\text{V}$			1.0	mA
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{V}$, $I_D = 1\text{mA}$	500			V
$V_{GS(th)}$	Gate-Source Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 10\text{mA}$	1.0		5.0	V
$R_{DS(on)}$	Drain-Source On-State Resistance	$I_D = 40\text{A}$, $V_{GS} = 15\text{V}$			110	$\text{m}\Omega$
$V_{DS(on)}$	Drain-Source On-State Voltage	$I_D = 40\text{A}$, $V_{GS} = 15\text{V}$			4.4	V
g_{fs}	Forward Transconductance	$V_{DS} = 10\text{V}$, $I_D = 40\text{A}$		40		S
C_{iss}	Input Capacitance	$V_{GS} = 0\text{V}$, $V_{DS} = 25\text{V}$, $f = 1.0\text{MHz}$			13500	pF
C_{oss}	Output Capacitance	$V_{GS} = 0\text{V}$, $V_{DS} = 25\text{V}$, $f = 1.0\text{MHz}$			2500	pF
C_{rss}	Reverse Transfer Capacitance	$V_{GS} = 0\text{V}$, $V_{DS} = 25\text{V}$, $f = 1.0\text{MHz}$			1000	pF
$td(on)$	Switching Time	Turn-on Delay Time		70		ns
tr		Rise Time		140		
$td(off)$		Turn-off Delay Time		700		
tf		Fall Time		210		
V_{SDS}	Diode Forward Voltage	$-I_S = 40\text{A}$, $V_{GS} = 0\text{V}$			2.5	V
trr	Reverse Recovery Time	$-I_S = 40\text{A}$, $V_{GS} = -5\text{V}$, $di/dt = 100\text{A}/\mu\text{s}$		80	100	ns
$R_{th(j-c)}$	Thermal Resistance	MOSFET			0.29	°C/W
		Diode			1.67	





MOSFET MODULE

FBA50CA45/50

TOP



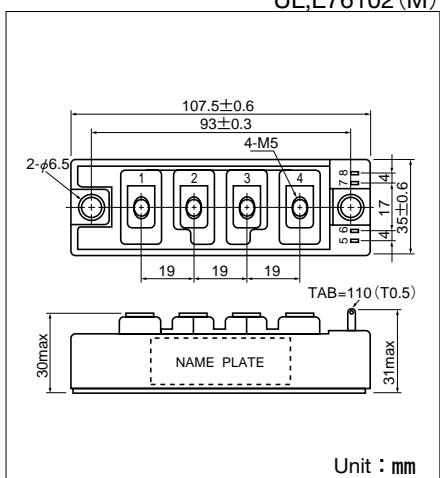
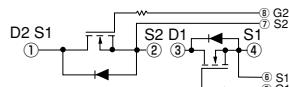
UL:E76102 (M)

FBA50CA45/50 is a dual power MOSFET module designed for fast switching applications of high voltage and current. (2 devices are serial connected.) The mounting base of the module is electrically isolated from semiconductor elements for simple heatsink construction.

- $I_D=50A$, $V_{DSS}=500V$
- Suitable for high speed switching applications.
- Low ON resistance.
- Wide Safe Operating Areas.

(Applications)

UPS(CVCF), Motor Control, Switching Power Supply, etc.



Unit : mm

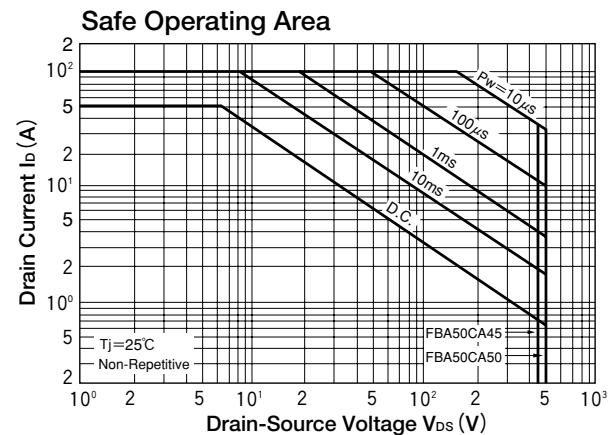
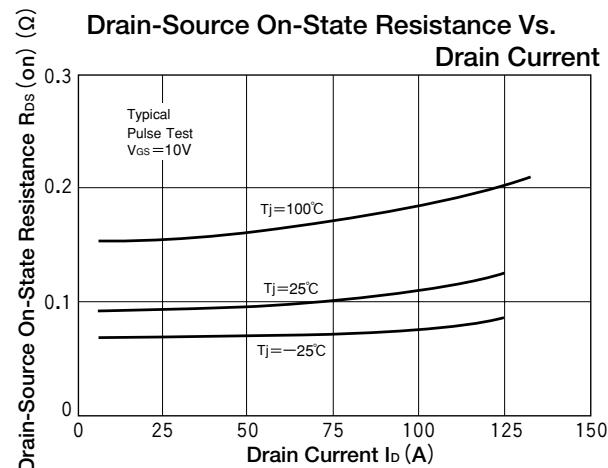
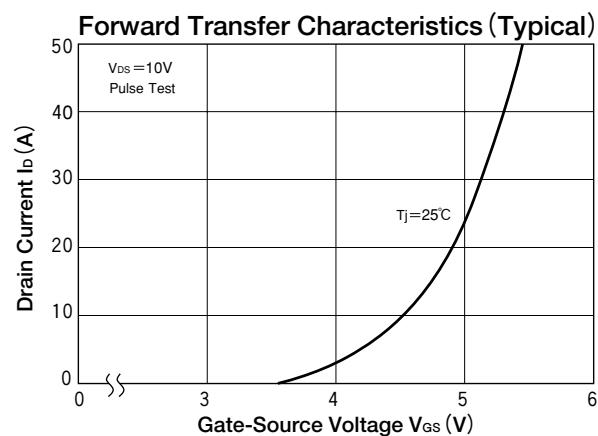
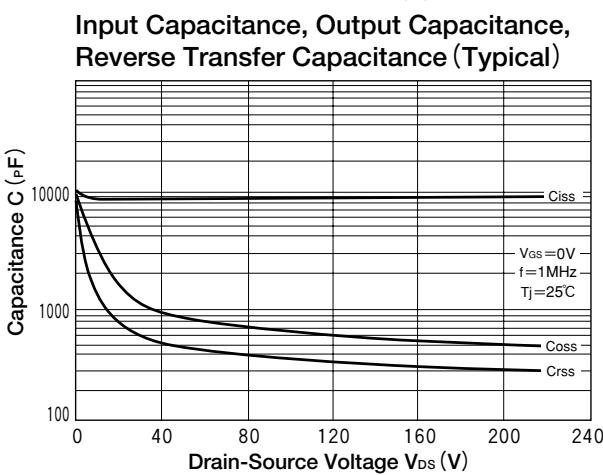
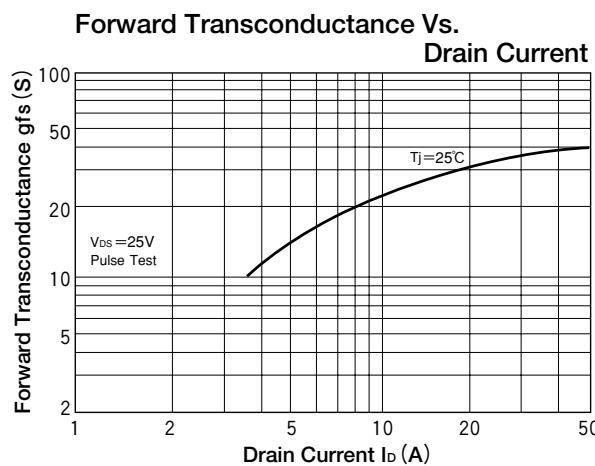
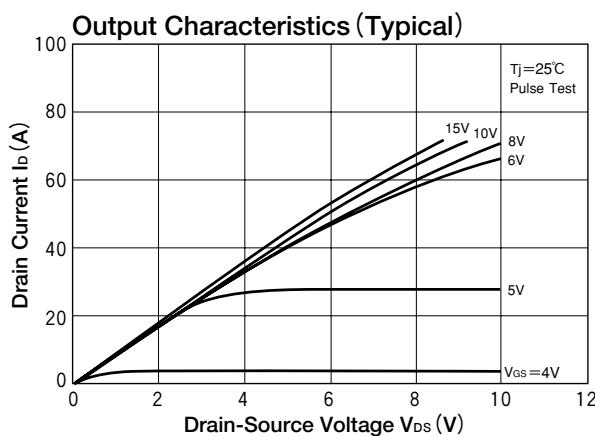
($T_j=25^\circ C$ unless otherwise specified)

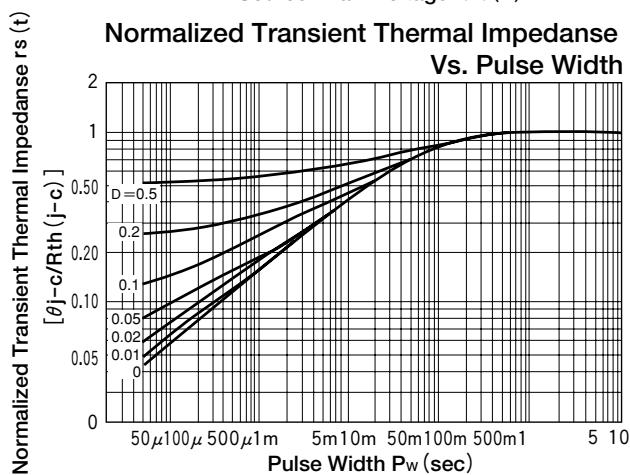
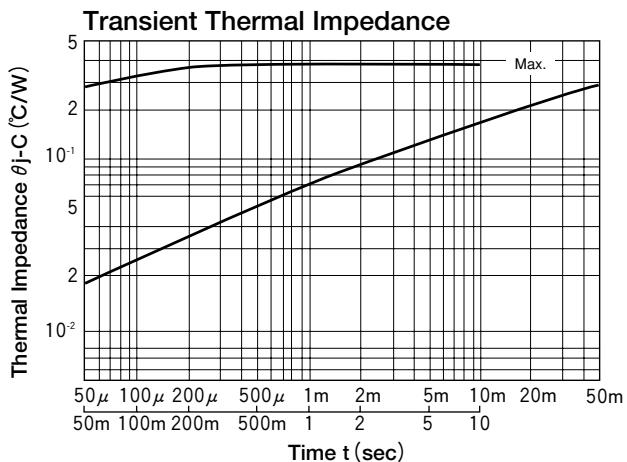
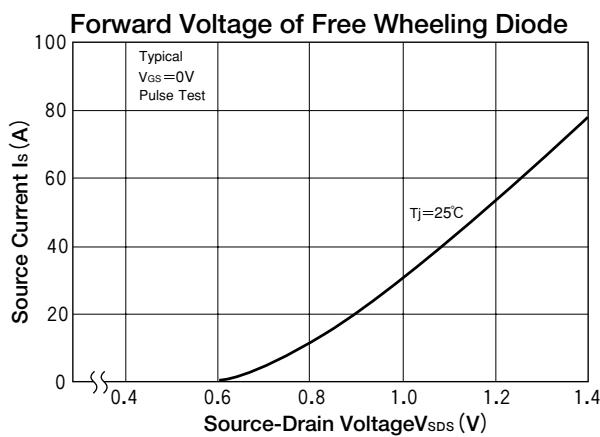
Symbol	Item	Conditions	Ratings		Unit
			FBA50CA45	FBA50CA50	
V_{DSS}	Drain-Source Voltage		450	500	V
V_{GSS}	Gate-Source Voltage		± 20		V
I_D I_{DP}	Drain Current D.C.		50		A
	Pulse		100		
$-I_D$	Source Current		50		A
P_T	Total Power Dissipation	$T_c=25^\circ C$	320		W
T_j	Channel Temperature		150		$^\circ C$
T_{stg}	Storage Temperature		-40 to $+125$		$^\circ C$
V_{iso}	Isolation Voltage (R.M.S.)	A.C. 1 minute	2500		V
T_{torque}	Mounting Torque	Mounting (M6)	Recommended Value 2.5-3.9 (25-40)		$N\cdot m$ (kgf·cm)
		Terminal (M5)	Recommended Value 1.5-2.5 (15-25)		
Mass		Typical Value	4.7 (48)	2.7 (28)	
			220		g

■Electrical Characteristics

($T_j=25^\circ C$ unless otherwise specified)

Symbol	Item	Conditions	Ratings			Unit
			Min.	Typ.	Max.	
I_{GSS}	Gate Leakage Current	$V_{GS}=\pm 20V$, $V_{DS}=0V$			± 1.0	μA
I_{DSS}	Zero Gate Voltage Drain Current	$V_{GS}=0V$, $V_{DS}=500V$			1.0	mA
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V$, $I_D=1mA$	450			V
	FBA50CA45		500			
$V_{GS(th)}$	Gate-Source Threshold Voltage	$V_{DS}=V_{GS}$, $I_D=10mA$	1.0		5.0	V
$R_{DS(on)}$	Drain-Source On-State Resistance	$I_D=25A$, $V_{GS}=15V$			120	$m\Omega$
$V_{DS(on)}$	Drain-Source On-State Voltage	$I_D=25A$, $V_{GS}=15V$			3.0	V
g_{fs}	Forward Transconductance	$V_{DS}=10V$, $I_D=25A$		30		S
C_{iss}	Input Capacitance	$V_{GS}=0V$, $V_{DS}=25V$, $f=1.0MHz$			10000	pF
C_{oss}	Output Capacitance	$V_{GS}=0V$, $V_{DS}=25V$, $f=1.0MHz$			1900	pF
C_{rss}	Reverse Transfer Capacitance	$V_{GS}=0V$, $V_{DS}=25V$, $f=1.0MHz$			750	pF
$t_{d(on)}$	Switching Time	Turn-on Delay Time		60		ns
tr		Rise Time		60		
$td(off)$		Turn-off Delay Time		650		
tf		Fall Time		130		
V_{SDS}	Diode Forward Voltage	$-I_D=25A$, $V_{GS}=0V$			1.5	V
trr	Reverse Recovery Time	$-I_D=25A$, $V_{GS}=0V$, $di/dt=100A/\mu s$		700		ns
$R_{th(j-c)}$	Thermal Resistance				0.39	$^\circ C/W$





MOSFET MODULE

FBA75CA45/50

TOP



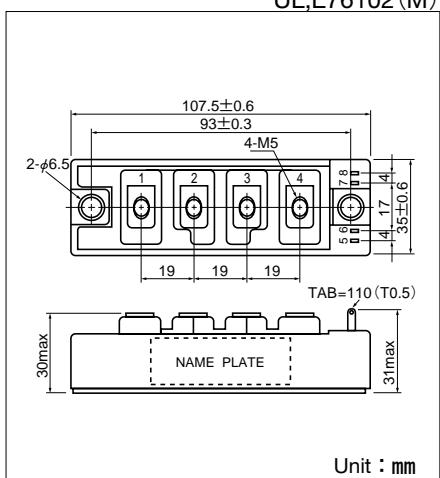
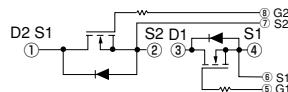
UL:E76102 (M)

FBA75CA45/50 is a dual power MOSFET module designed for fast switching applications of high voltage and current. (2 devices are serial connected.) The mounting base of the module is electrically isolated from semiconductor elements for simple heatsink construction.

- $I_D=75A$, $V_{DSS}=500V$
- Suitable for high speed switching applications.
- Low ON resistance.
- Wide Safe Operating Areas.

(Applications)

UPS(CVCF), Motor Control, Switching Power Supply, etc.



($T_j=25^\circ C$ unless otherwise specified)

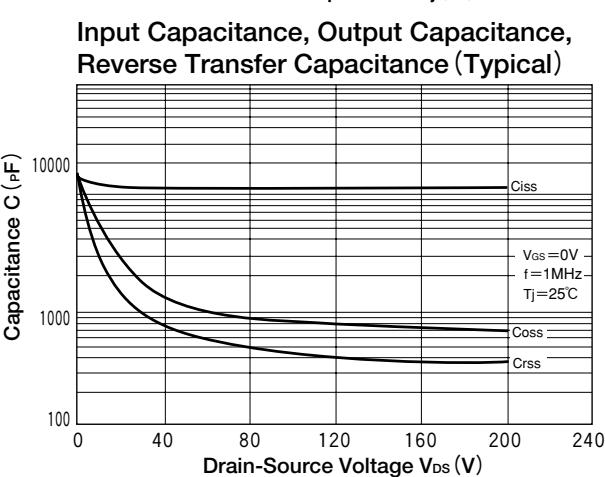
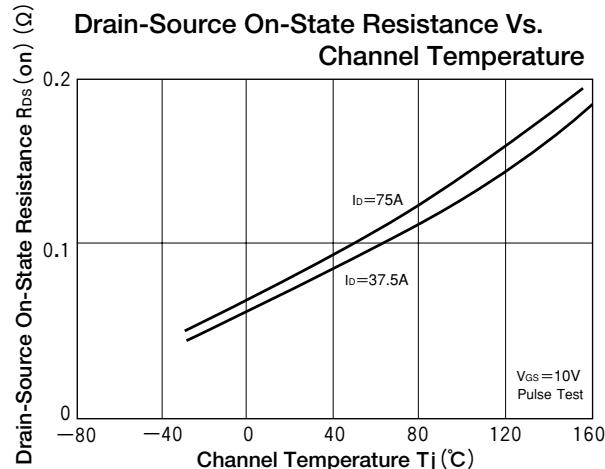
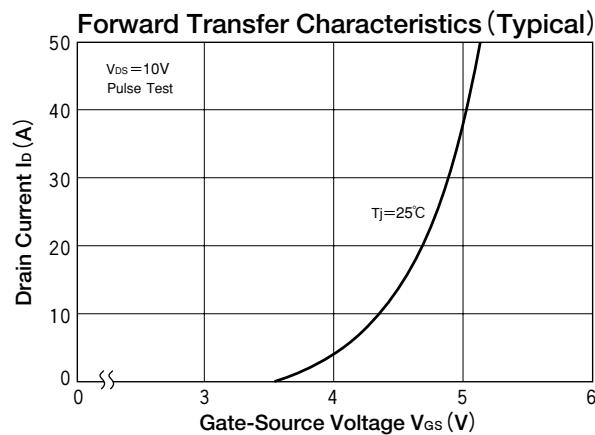
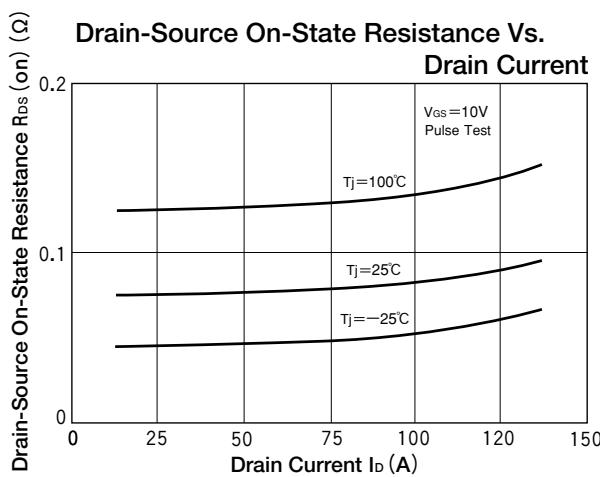
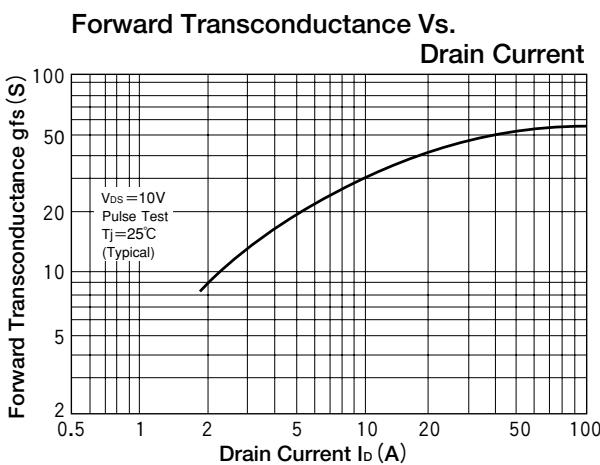
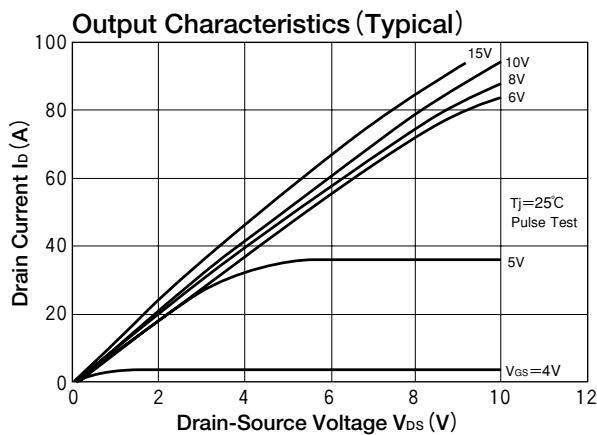
■ Maximum Ratings

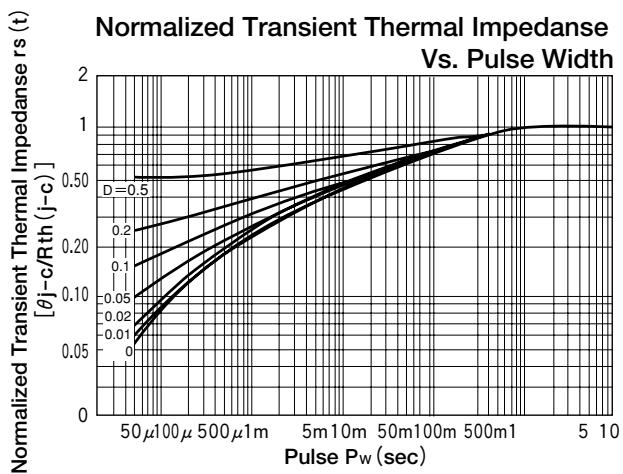
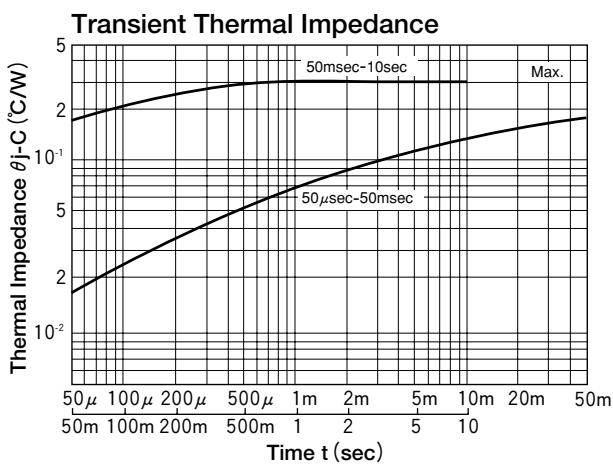
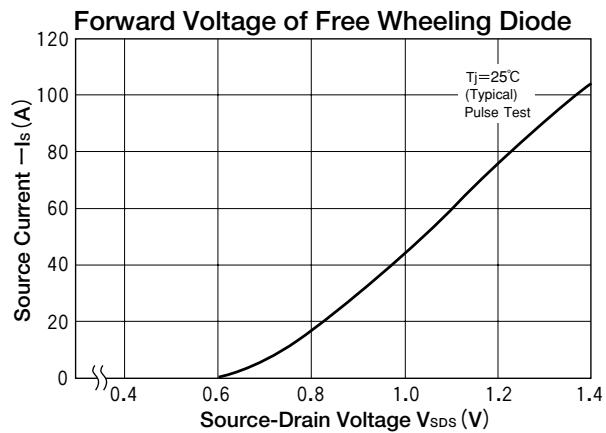
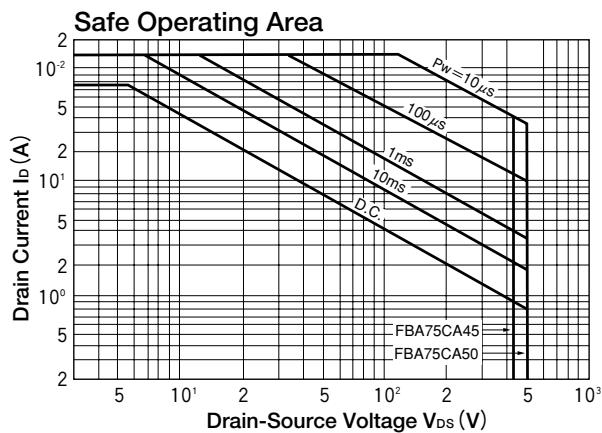
Symbol	Item	Conditions	Ratings		Unit
			FBA75CA45	FBA75CA50	
V_{DSS}	Drain-Source Voltage		450	500	V
V_{GSS}	Gate-Source Voltage		± 20		V
I_D I_{DP}	Drain Current D.C.	Duty=36%	75		A
	Pulse		150		
$-I_D$	Source Current		75		A
P_T	Total Power Dissipation	$T_c=25^\circ C$	400		W
T_j	Channel Temperature		150		$^\circ C$
T_{stg}	Storage Temperature		-40 to $+125$		$^\circ C$
V_{iso}	Isolation Voltage (R.M.S.)	A.C. 1 minute	2500		V
T_{stg} Mounting Torque	Mounting (M6)	Recommended Value 2.5-3.9 (25-40)	4.7 (48)		$N\cdot m$ (kgf·cm)
	Terminal (M5)	Recommended Value 1.5-2.5 (15-25)	2.7 (28)		
Mass	Typical Value		220		g

■ Electrical Characteristics

($T_j=25^\circ C$ unless otherwise specified)

Symbol	Item	Conditions	Ratings			Unit
			Min.	Typ.	Max.	
I_{GS}	Gate Leakage Current	$V_{GS}=\pm 20V$, $V_{DS}=0V$			± 1.0	μA
I_{DSS}	Zero Gate Voltage Drain Current	$V_{GS}=0V$, $V_{DS}=500V$			1.0	mA
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage FBA75CA45	$V_{GS}=0V$, $I_D=1mA$	450			V
	FBA75CA50		500			
$V_{GS(th)}$	Gate-Source Threshold Voltage	$V_{DS}=V_{GS}$, $I_D=10mA$	1.0		5.0	V
$R_{DS(on)}$	Drain-Source On-State Resistance	$I_D=40A$, $V_{GS}=15V$			0.10	Ω
$V_{DS(on)}$	Drain-Source On-State Voltage	$I_D=40A$, $V_{GS}=15V$			4.0	V
g_{fs}	Forward Transconductance	$V_{DS}=10V$, $V_D=40A$		40		S
C_{iss}	Input Capacitance	$V_{GS}=0V$, $V_{DS}=25V$, $f=1.0MHz$			13500	pF
C_{oss}	Output Capacitance	$V_{GS}=0V$, $V_{DS}=25V$, $f=1.0MHz$			2500	pF
C_{rss}	Reverse Transfer Capacitance	$V_{GS}=0V$, $V_{DS}=25V$, $f=1.0MHz$			1000	pF
$t_{d(on)}$	Turn-on Delay Time	$R_L=7.5\Omega$, $R_{GS}=50\Omega$, $V_{GS}=15V$ $I_D=40A$, $R_G=5\Omega$		60		ns
tr	Rise Time			120		
$td(off)$	Turn-off Delay Time			700		
tf	Fall Time			210		
V_{SDS}	Diode Forward Voltage	$-I_D=40A$, $V_{GS}=0V$			1.5	V
trr	Reverse Recovery Time	$-I_D=40A$, $V_{GS}=0V$, $di/dt=100A/\mu s$		700		ns
$R_{th(j-c)}$	Thermal Resistance				0.31	$^\circ C/W$





MOSFET MODULE

SF100BA50

TOP



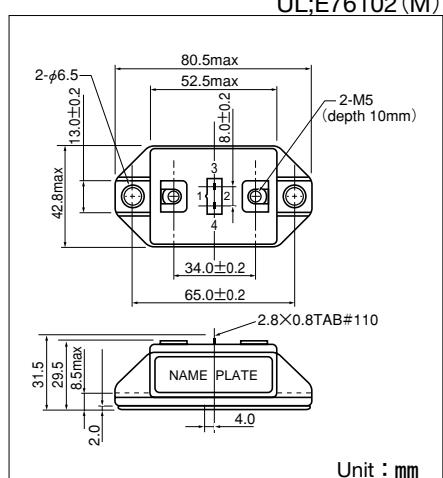
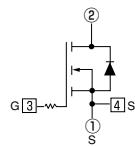
UL:E76102 (M)

SF100BA50 is a isolated power MOSFET module designed for fast switching applications of high voltage and current. The mounting base of the module is electrically isolated from semiconductor elements for simple heatsink construction.

- $I_D = 100A$, $V_{DSS} = 500V$
- Suitable for high speed switching applications.
- Low ON resistance.
- Wide Safe Operating Areas.
- $t_{rr} \leq 700ns$

(Applications)

UPS (CVCF), Motor Control, Switching Power Supply, etc.



Unit : mm

($T_j = 25^\circ C$ unless otherwise specified)

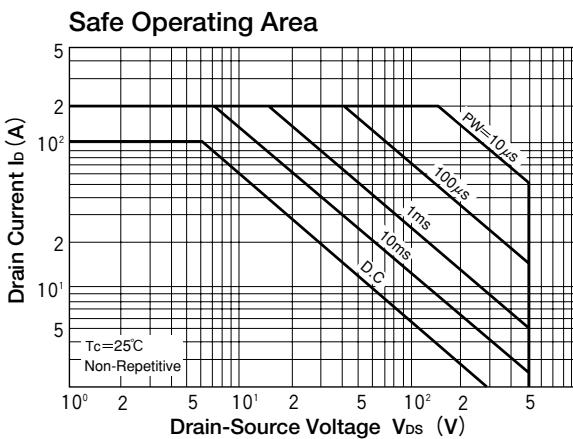
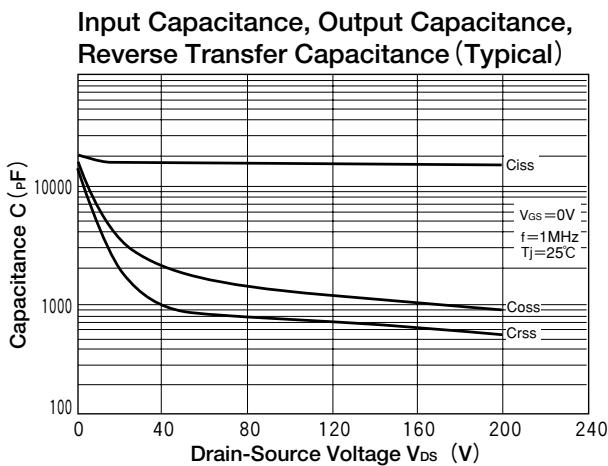
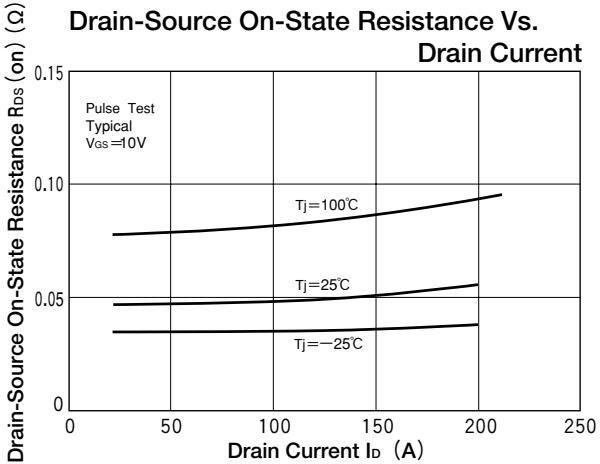
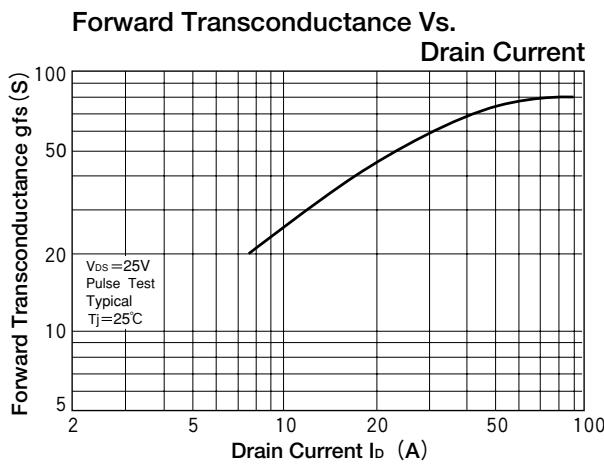
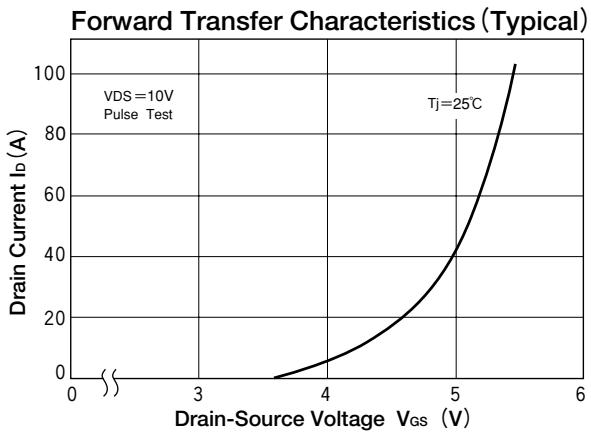
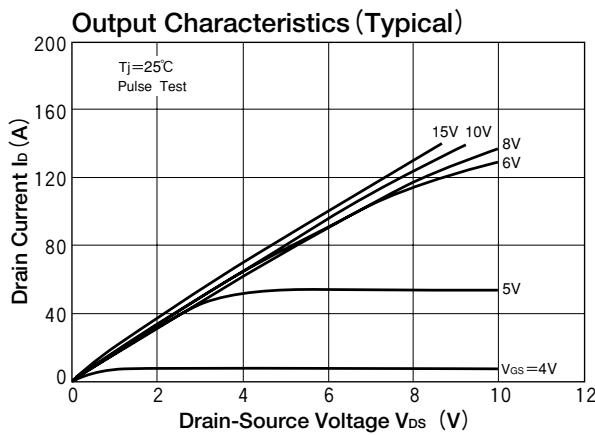
■ Maximum Ratings

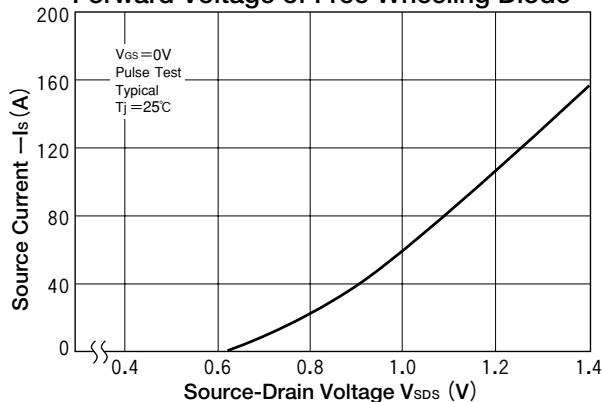
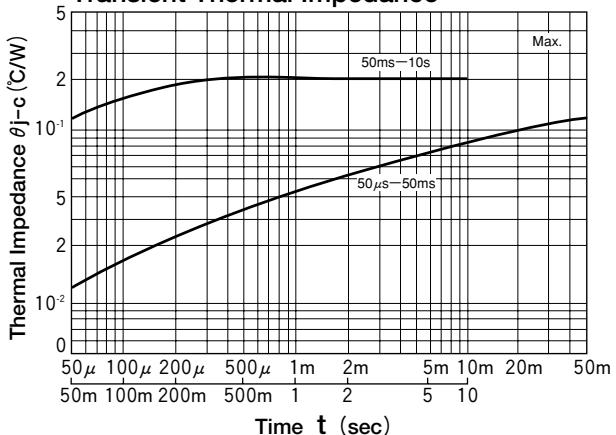
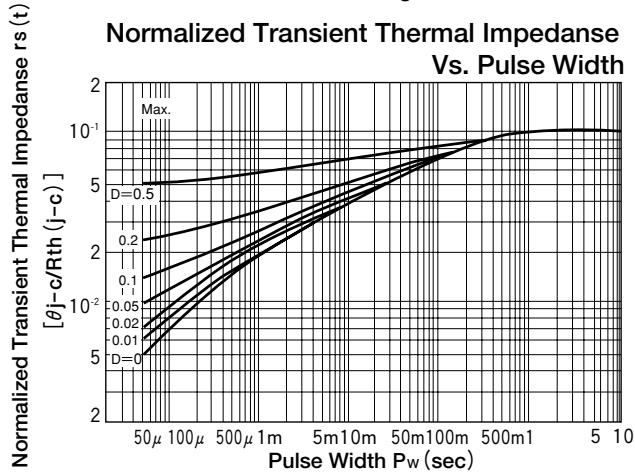
Symbol	Item	Conditions	Ratings	Unit
			SF100BA50	
V_{DSS}	Drain-Source Voltage		500	V
V_{GSS}	Gate-Source Voltage		±20	V
I_D I_{DP}	Drain Current DC	Duty=43%	100	A
	Pulse		200	
$-I_D$	Source Current		100	A
P_T	Total Power Dissipation	$T_c = 25^\circ C$	600	W
T_j	Channel Temperature		-40~+150	°C
T_{stg}	Storage Temperature		-40~+125	°C
V_{iso}	Isolation Voltage (R.M.S.)	A.C. 1minute	2500	V
Mounting Torque	Mounting (M6)	Recommended Value 2.5~3.9 (25~40)	4.7 (48)	N·m (kgf·cm)
	Terminal (M5)	Recommended Value 1.5~2.5 (15~25)	2.7 (28)	
Mass	Typical Value		160	g

■ Electrical Characteristics

($T_j = 25^\circ C$ unless otherwise specified)

Symbol	Item	Conditions	Ratings			Unit
			Min.	Typ.	Max.	
I_{GS}	Gate Leakage Current	$V_{GS} = \pm 20V$, $V_{DS} = 0V$			±2.0	μA
I_{DS}	Zero Gate Voltage Drain Current	$V_{GS} = 0V$, $V_{DS} = 500V$			1.0	mA
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0V$, $I_D = 1mA$	500			V
$V_{GS(th)}$	Gate-Source Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 10mA$	1.0		5.0	V
$R_{DS(on)}$	Drain-Source On-State Resistance	$I_D = 50A$, $V_{GS} = 15V$			70	$m\Omega$
$V_{DS(on)}$	Drain-Source On-State Voltage	$I_D = 50A$, $V_{GS} = 15V$			3.5	V
g_{fs}	Forward Transconductance	$V_{DS} = 10A$, $I_D = 50A$		60		S
C_{iss}	Input Capacitance	$V_{GS} = 0V$, $V_{DS} = 25V$, $f = 1.0MHz$			20000	pF
C_{oss}	Output Capacitance	$V_{GS} = 0V$, $V_{DS} = 25V$, $f = 1.0MHz$			3800	pF
$Crss$	Reverse Transfer Capacitance	$V_{GS} = 0V$, $V_{DS} = 25V$, $f = 1.0MHz$			1500	pF
$td(on)$	Turn-on Delay Time	$R_L = 6\Omega$, $R_{GS} = 50\Omega$, $V_{GS} = 15V$ $I_D = 50A$, $R_G = 5\Omega$		70		μs
tr	Rise Time			120		
$td(off)$	Turn-off Delay Time			1100		
tf	Fall Time			280		
V_{SDS}	Diode Forward Voltage	$-I_D = 50A$, $V_{GS} = 0V$			1.5	V
trr	Reverse Recovery Time	$-I_D = 50A$, $V_{GS} = 0V$, $di/dt = 100A/\mu s$		700		ns
$R_{th(j-c)}$	Thermal Resistance				0.21	°C/W



Forward Voltage of Free Wheeling Diode**Transient Thermal Impedance****Normalized Transient Thermal Impedance Vs. Pulse Width**

MOSFET MODULE

SF150BA50

TOP

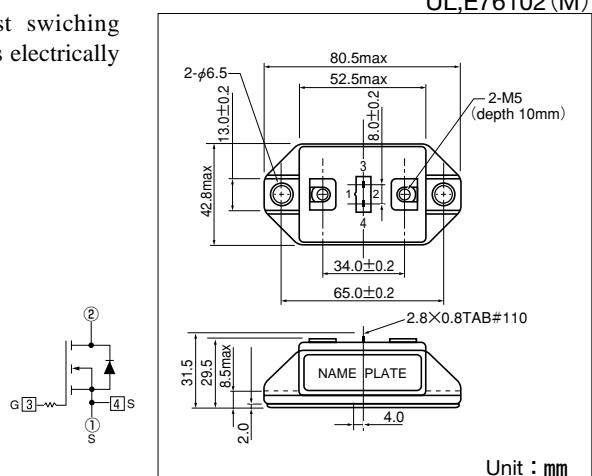


SF150BA50 is a isolated power MOSFET module designed for fast switching applications of high voltage and current. The mounting base of the module is electrically isolated from semiconductor elements for simple heatsink construction.

- $I_D=150A$, $V_{DSS}=500V$
- Suitable for high speed switching application.
- Low ON resistance.
- Wide Safe Operating Areas.

(Applications)

UPS(CVCF), Motor Control, Switching Power Supply, etc.



($T_j=25^\circ C$ unless otherwise specified)

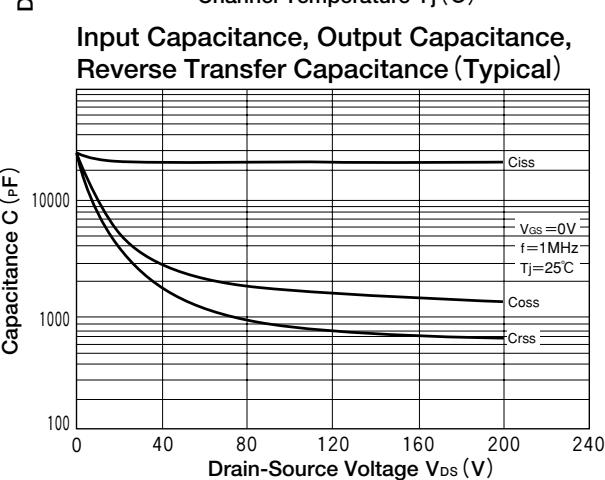
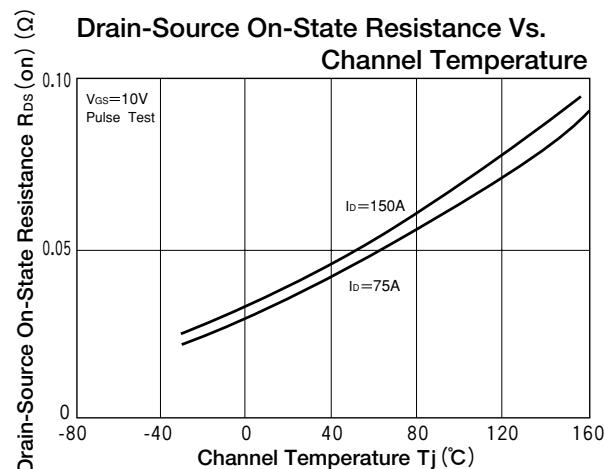
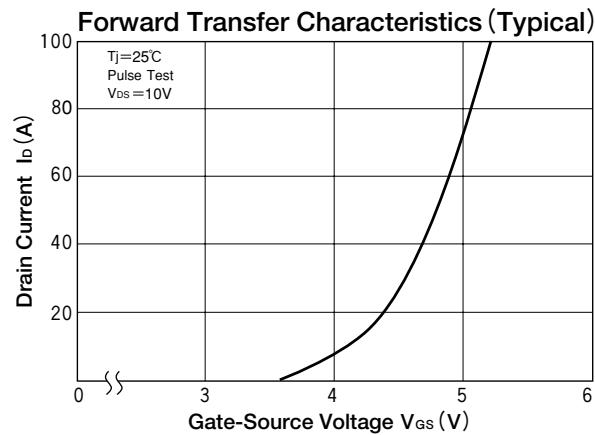
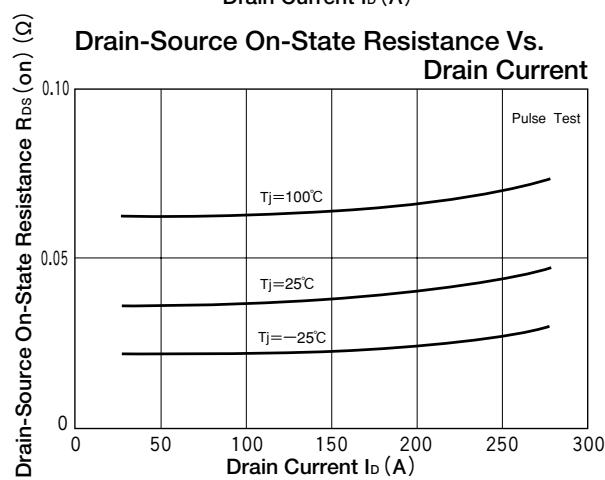
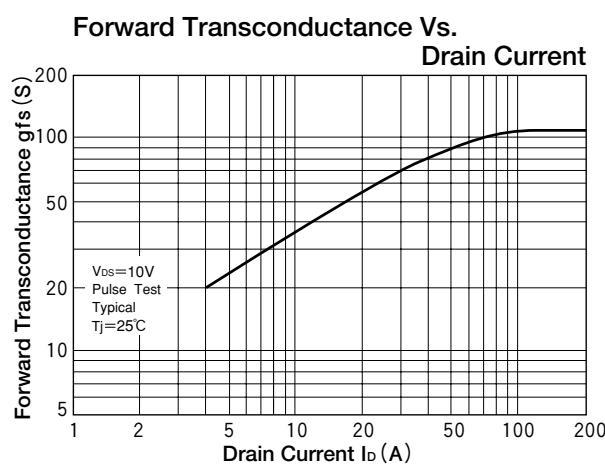
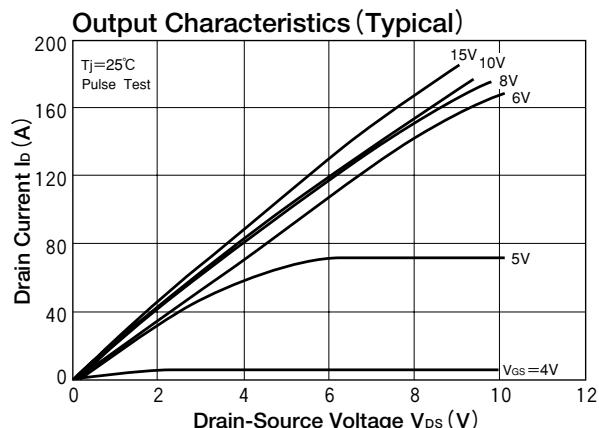
■ Maximum Ratings

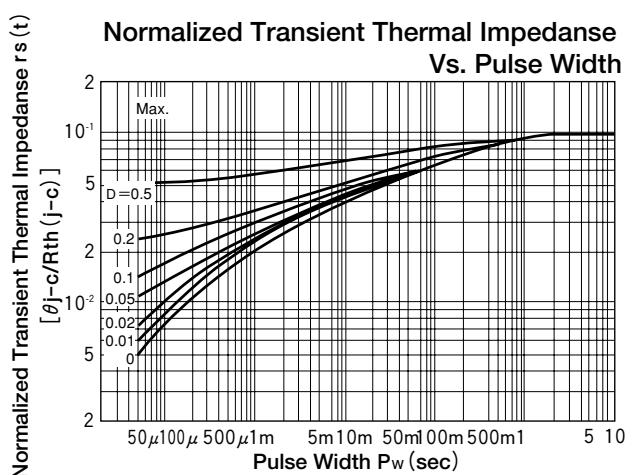
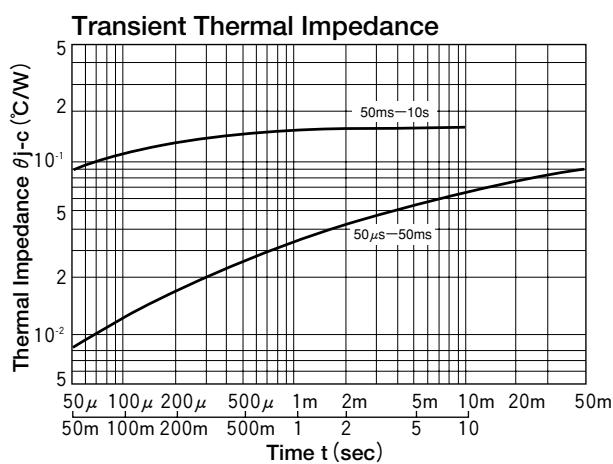
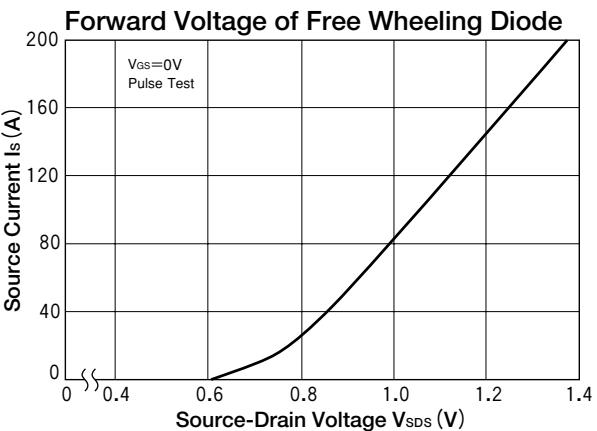
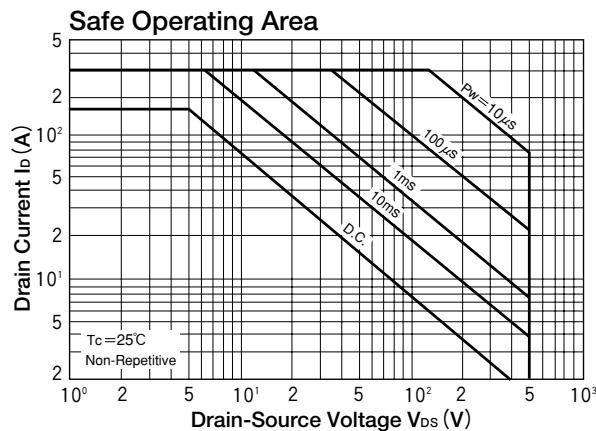
Symbol	Item	Conditions	Ratings	Unit
			SF150BA50	
V_{DSS}	Drain-Source Voltage		500	V
V_{GSS}	Gate-Source Voltage		± 20	V
I_D I_{DP}	Drain Current DC	Duty=35%	150	A
	Pulse		300	
$-I_D$	Source Current		150	A
P_T	Total Power Dissipation	$T_c=25^\circ C$	780	W
T_j	Channel Temperature		-40 to +150	$^\circ C$
T_{stg}	Storage Temperature		-40 to +125	$^\circ C$
V_{iso}	Isolation Voltage (R.M.S.)	A.C. 1 minute	2500	V
Mounting Torque	Mounting (M6)	Recommended Value 2.5-3.9 (25-40)	4.7 (48)	N·m (kgf·cm)
	Terminal (M5)	Recommended Value 1.5-2.5 (15-25)	2.7 (28)	
Mass	Typical Value		160	g

■ Electrical Characteristics

($T_j=25^\circ C$ unless otherwise specified)

Symbol	Item	Conditions	Ratings			Unit
			Min.	Typ.	Max.	
I_{GS}	Gate Leakage Current	$V_{GS}=\pm 20V$, $V_{DS}=0V$			± 2.0	μA
I_{DSS}	Zero Gate Voltage Drain Current	$V_{GS}=0V$, $V_{DS}=500V$			2.0	mA
$V_{(BR)DSS}$	Darin-Source Breakdown Voltage	$V_{GS}=0V$, $I_D=1mA$	500			V
$V_{GS(th)}$	Gate-Source Threshold Voltage	$V_{DS}=V_{GS}$, $I_D=10mA$	1.0		5.0	V
$R_{DS(on)}$	Drain-Source On-State Resistance	$I_D=75A$, $V_{GS}=15V$			50	$m\Omega$
$V_{DS(on)}$	Drain-Source On-State Voltage	$I_D=75A$, $V_{GS}=15V$			3.75	V
g_{fs}	Forward Transconductance	$V_{DS}=10V$, $I_D=75A$		80		S
C_{iss}	Input Capacitance	$V_{GS}=0V$, $V_{DS}=25V$, $f=1.0MHz$			27000	pF
C_{oss}	Output Capacitance	$V_{GS}=0V$, $V_{DS}=25V$, $f=1.0MHz$			5000	pF
$Crss$	Reverse Transfer Capacitance	$V_{GS}=0V$, $V_{DS}=25V$, $f=1.0MHz$			2000	pF
$td(on)$	Switching Time	Turn-on Delay Time			90	ns
tr		Rise Time			180	
$td(off)$		Turn-off Delay Time	$R_L=4\Omega$, $R_{GS}=50\Omega$, $V_{GS}=15V$		1400	
tf		Fall Time	$I_D=75A$, $R_G=5\Omega$		360	
V_{SDS}	Diode Forward Voltage	$-I_D=75A$, $V_{GS}=0V$			1.5	V
trr	Reverse Recovery Time	$-I_D=75A$, $V_{GS}=0V$, $di/dt=100A/\mu s$		700		ns
$R_{th(j-c)}$	Thermal Resistance				0.16	$^\circ C/W$





MOSFET MODULE

SF100CB100

TOP

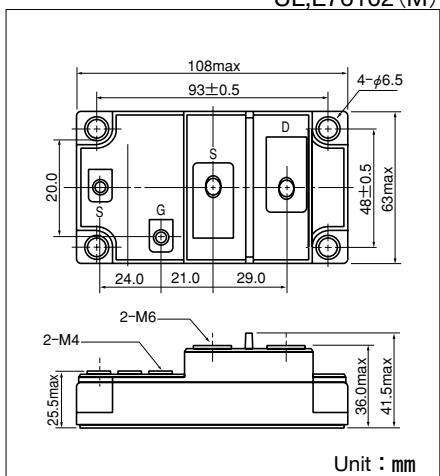
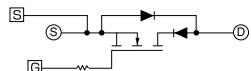


UL:E76102 (M)

SF100CB100 is a isolated power MOSFET module designed for fast switching applications of high voltage and current with a fast recovery diode ($t_{rr} \leq 300\text{ns}$) reverse connected. The mounting base of the module is electrically isolated from semiconductor elements for simple heatsink construction.

- $I_D = 100\text{A}$, $V_{DSS} = 1000\text{V}$
- Suitable for high speed switching applications.
- Low ON resistance.
- Wide Safe Operating Areas.
- $t_{rr} \leq 300\text{ns}$ fast recovery diode for free wheel

(Applications)



($T_j = 25^\circ\text{C}$ unless otherwise specified)

■ Maximum Ratings

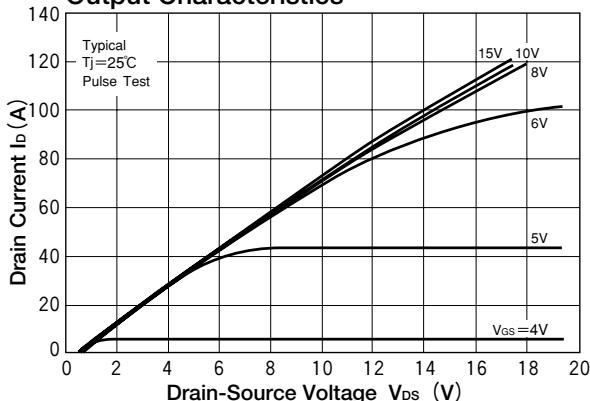
Symbol	Item	Conditions	Ratings	Unit
			SF100CB100	
V_{DSS}	Drain-Source Voltage		1000	V
V_{GSS}	Gate-Source Voltage		±30	V
I_D	Drain Current	DC	100	A
I_{DP}	Current	Pulse	200	
$-I_D$	Source Current		100	A
P_T	Total Power Dissipation	$T_c = 25^\circ\text{C}$	800	W
T_j	Channel Temperature		-40 to +150	°C
T_{stg}	Storage Temperature		-40 to +125	°C
V_{iso}	Isolation Voltage (R.M.S.)	A.C. 1minute	2500	V
Mounting Torque	Mounting (M6)	Recommended Value 2.5-3.9 (25-40)	4.7 (48)	N·m (kgf·cm)
	Terminal (M6)	Recommended Value 2.5-3.9 (25-40)	4.7 (48)	
	Terminal (M4)	Recommended Value 1.0-1.4 (10-14)	1.5 (15)	
Mass	Typical Value		460	g

■ Electrical Characteristics

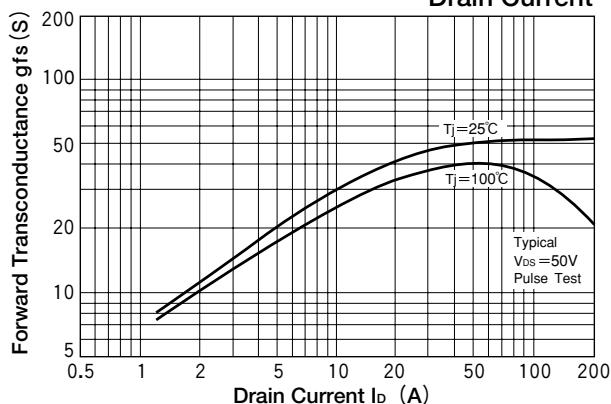
($T_j = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Item	Conditions	Ratings			Unit
			Min.	Typ.	Max.	
I_{GSS}	Gate Leakage Current	$V_{GS} = \pm 20\text{V}$, $V_{DS} = 0\text{V}$			±0.1	μA
I_{DSS}	Zero Gate Voltage Drain Current	$V_{GS} = 0\text{V}$, $V_{DS} = 800\text{V}$			4.0	mA
$V_{(BR)DSS}$	Darin-Source Breakdown Voltage	$V_{GS} = 0\text{V}$, $I_D = 1\text{mA}$	1000			V
$V_{GS(th)}$	Gate-Source Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 10\text{mA}$	1.5		3.5	V
$R_{DS(on)}$	Drain-Source On-State Resistance	$I_D = 100\text{A}$, $V_{GS} = 15\text{V}$			150	$\text{m}\Omega$
$V_{DS(on)}$	Drain-Source On-State Voltage	$I_D = 100\text{A}$, $V_{GS} = 15\text{V}$			15	V
g_{fs}	Forward Transconductance	$V_{DS} = 10\text{A}$, $V_D = 75\text{A}$	30	50		S
C_{iss}	Input Capacitance	$V_{GS} = 0\text{V}$, $V_{DS} = 25\text{V}$, $f = 1.0\text{MHz}$		16000	19200	pF
C_{oss}	Output Capacitance	$V_{GS} = 0\text{V}$, $V_{DS} = 25\text{V}$, $f = 1.0\text{MHz}$		2900	4200	pF
$Crss$	Reverse Transfer Capacitance	$V_{GS} = 0\text{V}$, $V_{DS} = 25\text{V}$, $f = 1.0\text{MHz}$		1800	2600	pF
$td(on)$	Switching Time	Turn-on Delay Time			150	ns
tr		Rise Time			300	
$td(off)$		Turn-off Delay Time			600	
tf		Fall Time			300	
V_{SDS}	Diode Forward Voltage	$-I_D = 100\text{A}$, $V_{GS} = 0\text{V}$			1.8	V
trr	Reverse Recovery Time	$-I_D = 100\text{A}$, $V_{GS} = 15\text{V}$, $di/dt = 400\text{A}/\mu\text{s}$			300	ns
$R_{th(j-c)}$	Thermal Resistance	MOSFET			0.16	°C/W
		Diode			0.64	

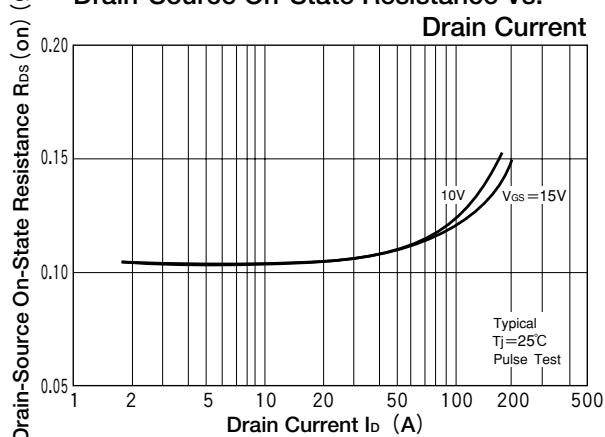
Output Characteristics



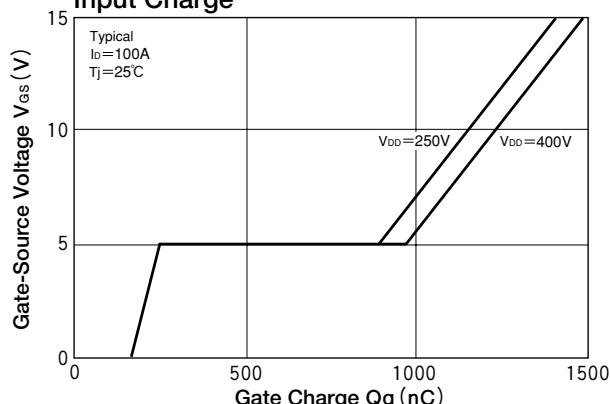
Forward Transconductance Vs. Drain Current



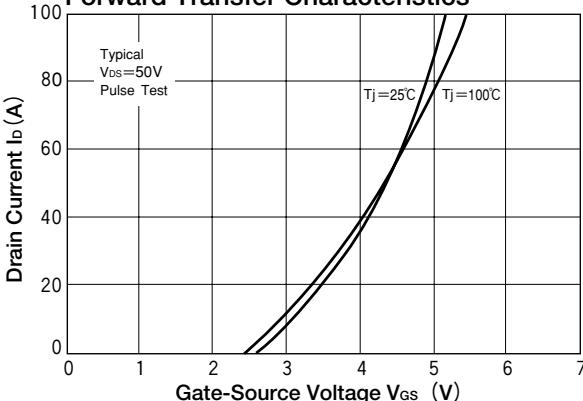
Drain-Source On-State Resistance Vs. Drain Current



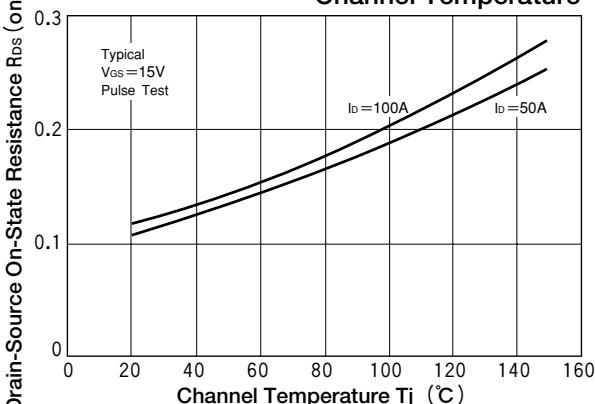
Input Charge



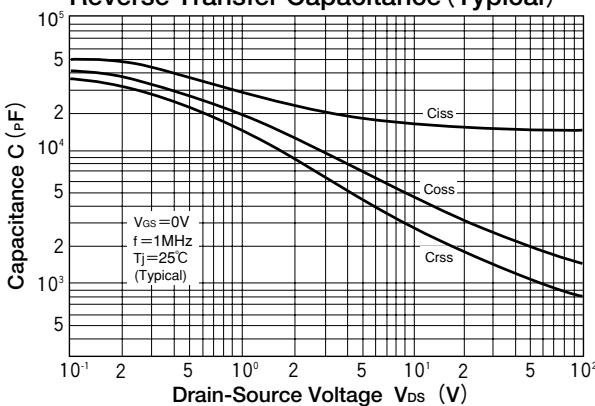
Forward Transfer Characteristics



Drain-Source On-State Resistance Vs. Channel Temperature



Input Capacitance, Output Capacitance, Reverse Transfer Capacitance (Typical)



Safe Operating Area

